

-30V P-Channel Enhancement Mode MOSFET

DESCRIPTION

The STP4407 is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density, advanced trench technology to provide excellent $R_{DS(ON)}$. This device is suitable for use as a load switch or in PWM and gate charge for most of the synchronous buck converter applications.

STP4407M-TRG ROHS Compliant This is Halogen Free

FEATURE

- ◆ -30V/-12.0A, $R_{DS(ON)} = 11.5m\Omega (typ) @ V_{GS} = -10V$
- ◆ -30V/-10.0A, $R_{DS(ON)} = 16.5m\Omega (typ) @ V_{GS} = -4.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP-8 package design

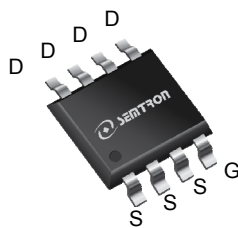
APPLICATIONS

- ◆ High Frequency Point-of-Load Synchronous
- ◆ Newworking DC-DC Power System
- ◆ Portable Battery Pack
- ◆ Load Switch

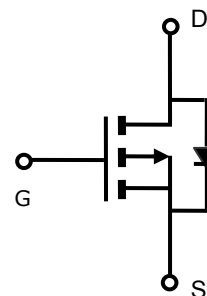


P-Channel Enhancement Mode MOSFET

PIN CONFIGURATION



SOP-8
Top View



PART NUMBER INFORMATION

<p>STP 4407 M - TR G</p> <p>a b c d e</p>	<p>a : Company name. b : Product Serial number. c : Package code d : Handling code e : Green produce code</p>
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ORDERING INFORMATION

Part Number	Package Code	Handling Code	Shipping
STP4407M-TRG	M : SOP-8	TR : Tape&Reel	2.5K/Reel

※ Year Code : 0 ~ 9, 2010 : 0
 ※ Week Code : A(1~2) ~ Z(53~54)
 ※ SOP-8 : Only available in tape and reel packaging.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C Unless otherwise noted)

Symbol	Parameter	Typical	Unit
V _{DSS}	Drain-Source Voltage	-30	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Continuous Drain Current (T _C =25°C) ^A	V _{GS} =10V	A
	Continuous Drain Current (T _C =70°C)		A
I _{DM}	Pulsed Drain Current ^B	-40	A
E _{AS}	Single Pulse Avalanche energy L=0.1mH ^C	270	mJ
P _D	Power Dissipation	T _A =25°C	3.2
		T _A =70°C	2
T _J	Operation Junction Temperature	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C

Note:

- A. The value of R_{θJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.
 B. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%

Absolute maximum ratings are those values beyond which the device could be permanently damaged.
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.

THERMAL DATA

Symbol	Parameter	Typ	Max	Unit
R _{θJA}	Thermal Resistance-Junction to Ambient ^A	Steady-State	-	50 °C/W
R _{θJL}	Thermal Resistance Junction to Lead ^A	Steady-State	-	30 °C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ Unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Parameters						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	-30			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1.0		-2.5	V
I_{GSS}	Gate Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -24V, V_{GS} = 0V$			-1	μA
		$V_{DS} = -24V, V_{GS} = 0V$ $T_J = 55^\circ\text{C}$			-5	
$R_{DS(ON)}$	Drain-source On-Resistance ^B	$V_{GS} = -10V, I_D = -12.0A$ $V_{GS} = -4.5V, I_D = -10.0A$		11.5 16.5	15 20	m Ω
G_{fs}	Forward Transconductance	$V_{DS} = -5V, I_D = -10.0A$		10.5		S
Source-Drain Diode						
V_{SD}	Diode Forward Voltage	$I_S = -1A, V_{GS} = 0V$		-0.75		V
I_S	Continuous Source Current ^{AD}				-10	A
Dynamic Parameters						
Q_g	Total Gate Charge	$V_{DS} = -15V, V_{GS} = -4.5V,$ $I_D = -8.0A$		15		nC
Q_{gs}	Gate-Source Charge			4.1		
Q_{gd}	Gate-Drain Charge			6.4		
C_{iss}	Input Capacitance	$V_{DS} = -15V, V_{GS} = 0V,$ $f = 1\text{MHz}$		2350		pF
C_{oss}	Output Capacitance			220		
C_{rss}	Reverse Transfer Capacitance			152		
$t_{d(on)}$	Turn-On Time	$V_{DD} = 15V, V_{GS} = -10V,$ $I_D = -5A, R_G = 6\Omega$		9.4		nS
T_r				22		
$t_{d(off)}$	Turn-Off Time			62		
t_f				14.6		

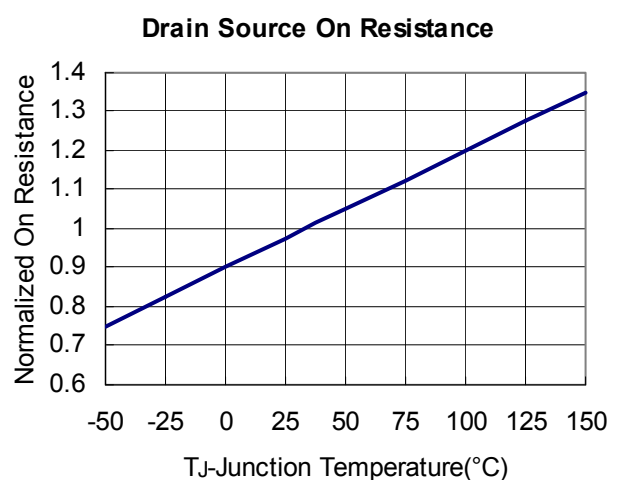
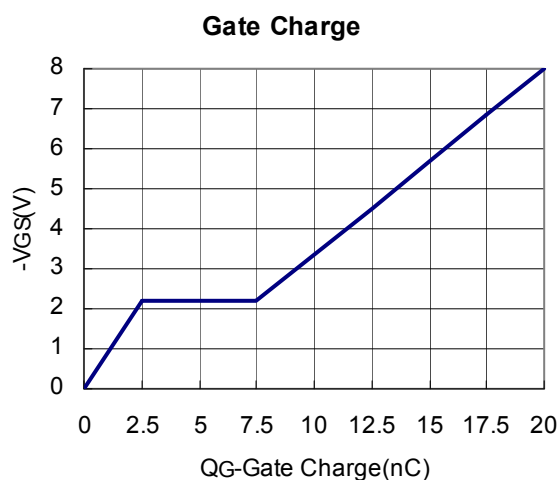
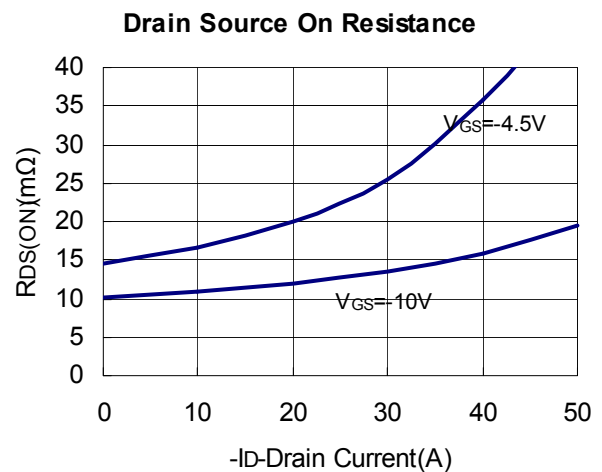
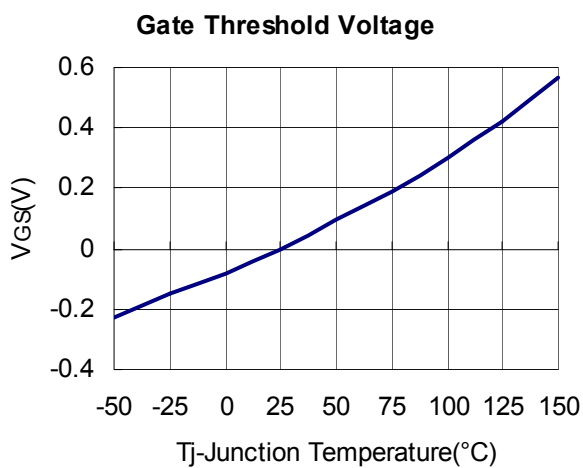
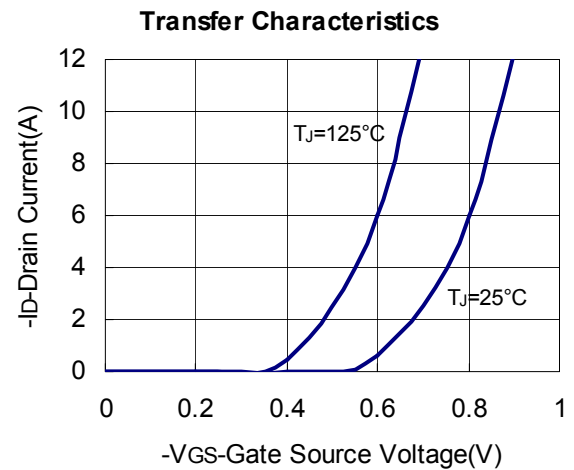
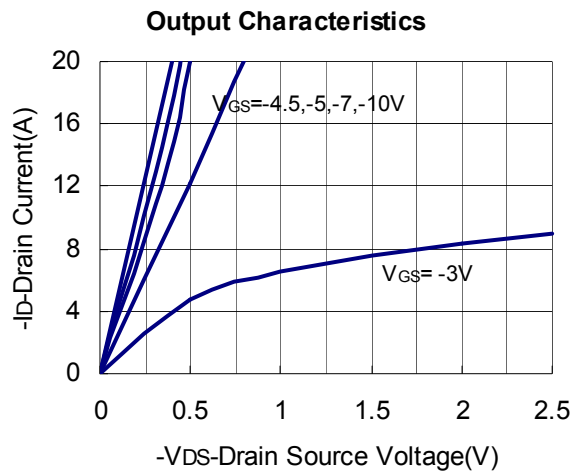
Note:

- The value of $R_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_C = 25^\circ\text{C}$.
- The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- The EAS data shows Max. rating. The test condition is $V_{DD} = -25V, V_{GS} = -10V, L = 0.1\text{mH}$.
- The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

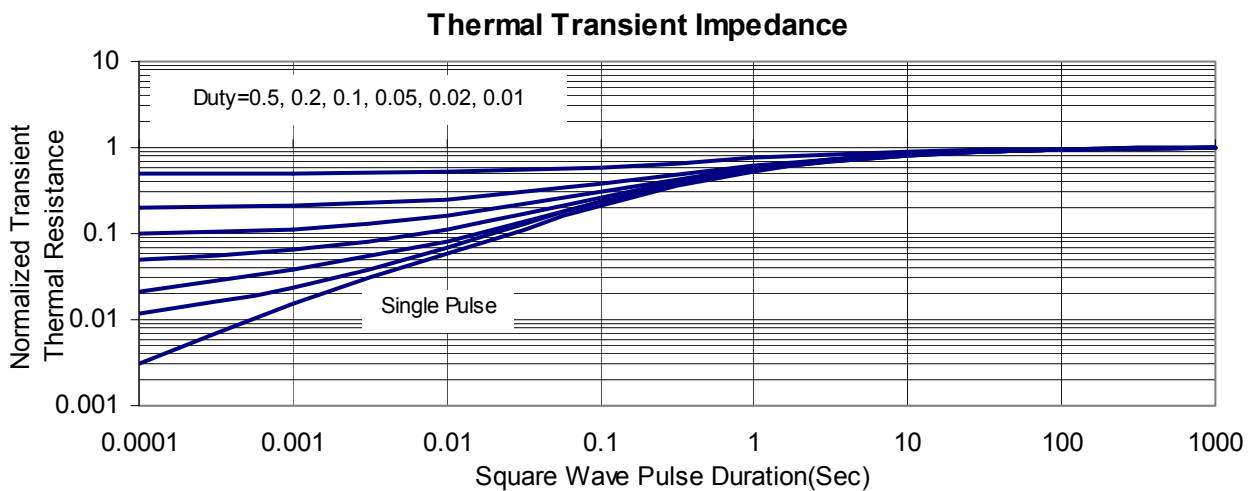
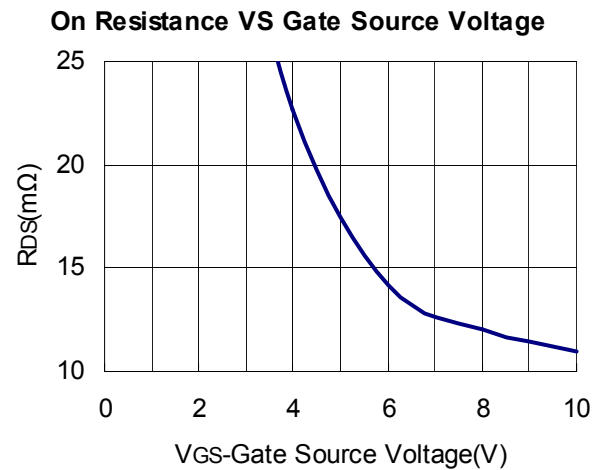
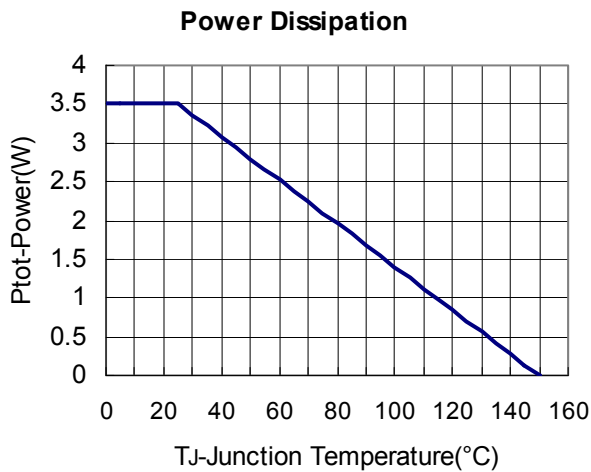
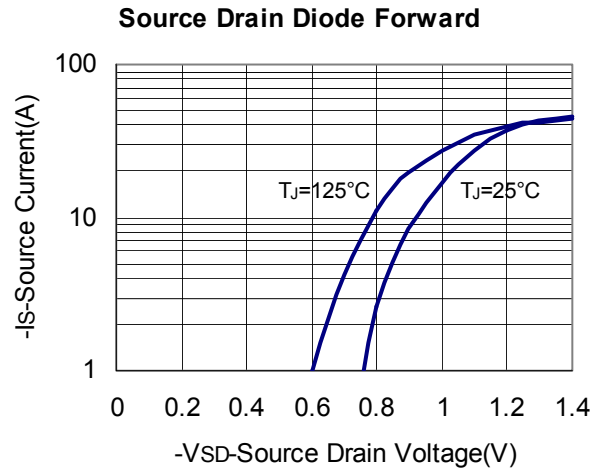
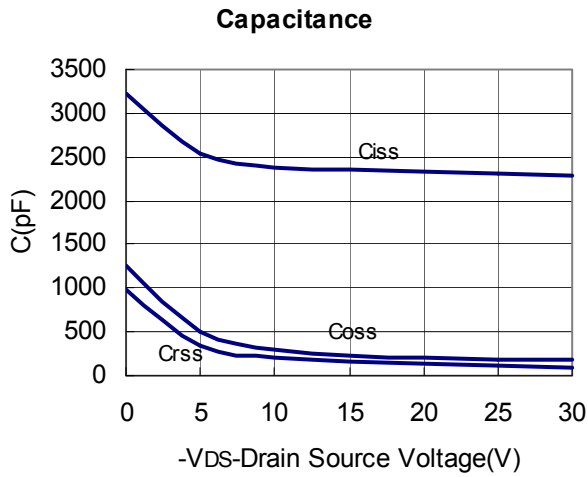
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TYPICAL CHARACTERISTICS (25°C Unless Note)



TYPICAL CHARACTERISTICS (25°C Unless Note)



SOP-8 PACKAGE DIMENSIONS

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.040	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

